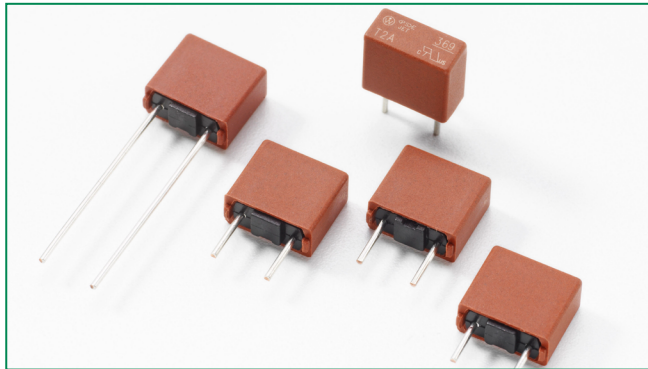






## 369 Series, TE5® Time-Lag Fuse



### Agency Approvals

Agency	Agency File Number	Ampere Range
	E67006	800mA - 6.3A
	JET 1896-31007-2002	1A - 5A
	1023263	1A - 6.3A
	DE1-52036	1A, 1.6A, 2A, 3.15A, 4A, 6.3A

### Description

TE5®, Time-lag type, 300V rated and designed in accordance to IEC60127-3.

### Features

- Lead-free
- Reduced PCB space requirements
- Direct solderable or plug-in versions
- Internationally approved
- Low internal resistance
- Shocksafe casing
- Vibration resistant
- Halogen free





### Applications

- Electronic Ballast

### Electrical Characteristics for Series

% of Ampere Rating	Opening Time
150%	1 Hour, Minimum
210%	120 sec., Maximum
275%	400 ms., Min.; 10 sec., Max.
400%	150 ms., Min.; 3 sec., Max.
1000%	20 ms., Min.; 150 ms., Max.

### Electrical Characteristics

Amp Code	Amp Rating (A)	Voltage Rating (V)	Breaking Capacity	Voltage Drop $1.0 \times I_N$ max. (mV)	Power Dissipation $1.5 \times I_N$ max. (mW)	Melting Integral $10 \times I_N$ min. (A <sup>2</sup> s)	Agency Approvals			
										
0800	0.800	300	50A@300VAC 50-60 Hz/cosφ = 1	110	280	3.80	x			
1100	1.00	300		115	400	5.80	x	x	x	x
1160	1.60	300		95	600	13.50	x	x	x	x
1200	2.00	300		90	700	21.00	x	x	x	x
1315	3.15	300		80	1100	55.00	x	x	x	x
1400	4.00	300		75	1200	100.00	x	x	x	x
1500	5.00	300		70	1000	90.00	x	x	x	
1630	6.30	300		65	1200	126.00	x		x	x

### Additional Information



Datasheet

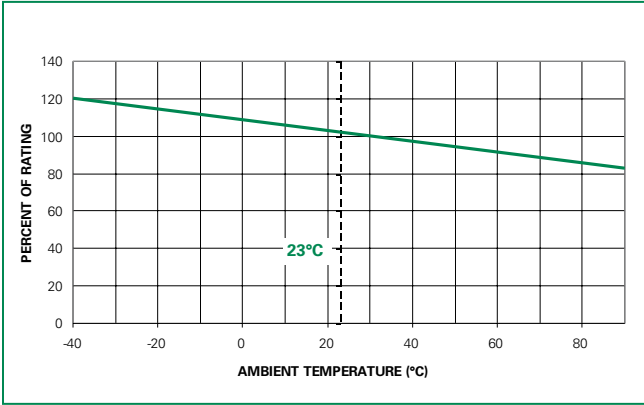


Resources

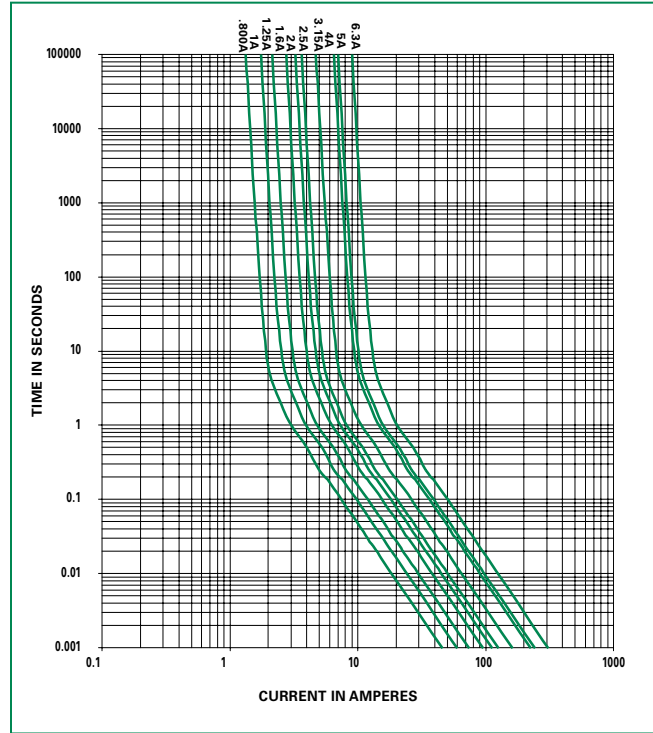


Samples

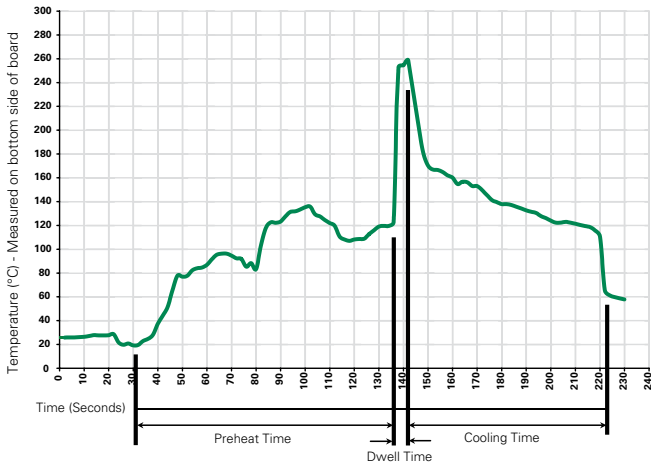
**Temperature Derating Curve**



**Average Time Current Curves**



**Soldering Parameters - Wave Soldering**



**Recommended Process Parameters:**

Wave Parameter	Lead-Free Recommendation
<b>Preheat:</b> (Depends on Flux Activation Temperature)	(Typical Industry Recommendation)
Temperature Minimum:	100° C
Temperature Maximum:	150° C
Preheat Time:	60-180 seconds
<b>Solder Pot Temperature:</b>	260° C Maximum
<b>Solder Dwell Time:</b>	2-5 seconds

**Recommended Hand-Solder Parameters:**

Solder Iron Temperature: 350° C +/- 5° C  
Heating Time: 5 seconds max.

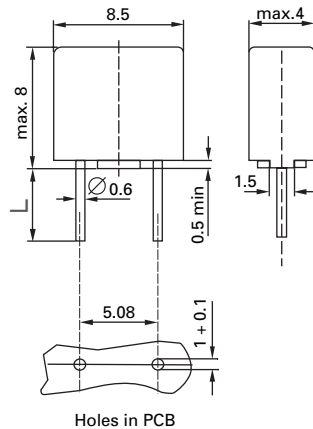
**Note: These devices are not recommended for IR or Convection Reflow process.**

## Product Characteristics

<b>Materials</b>	Base/Cap: Brown Thermoplastic Polyamide PA6.6, UL 94 V0 Round Pins: Tin-plated Copper
<b>Lead Pull Strength</b>	10 N (IEC 60068-2-21)
<b>Solderability</b>	260°C, ≤ 3s (Wave) 350°C, ≤ 1s (Soldering Iron)
<b>Soldering Heat Resistance</b>	260°C, 10s (IEC60068-2-20) 350°C, 3s (Soldering Iron)

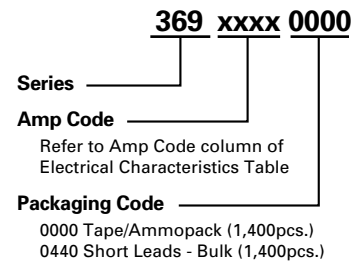
<b>Operating Temperature</b>	-40°C to +85°C (consider de-rating)
<b>Climatic Category</b>	-40°C / +85°C / 21 days (EN60068-1,-2-1,-2-2,-2-78)
<b>Stock Condition</b>	+10°C to +60°C relative humidity 75% yearly average, without dew, maximum value for 30 days-95%
<b>Vibration Resistance</b>	24 cycles at 15min. Each (EN60068-2-6) 10 - 60 Hz at 0.75 mm amplitude 60 - 2000 Hz at 10g acceleration

## Dimensions



Long Leads (L=18.8mm)  
Short Leads (L=4.3mm)

## Part Numbering System



## Packaging

Packaging Option	Packaging Specification	Quantity	Quantity & Packaging Code	Taping Width
<b>369 Series</b>				
Tape & Ammopack	N/A	1,400	0000	N/A
Short Leads	N/A	1,400	0440	N/A